

6-Pin DIP High BV_{CEO} Phototransistor Optocouplers

CNY17 Series, MOC8106M

Description

The CNY17XM, CNY17FXM, and MOC8106M devices consist of a gallium arsenide infrared emitting diode coupled with an NPN phototransistor in a dual in-line package.

Features

- High BV_{CEO}: 70 V Minimum (CNY17XM, CNY17FXM, MOC8106M)
- Closely Matched Current Transfer Ratio (CTR) Minimizes Unit-to-Unit Variation
- Current Transfer Ratio In Select Groups
- Very Low Coupled Capacitance Along With No Chip-to-Pin 6 Base Connection for Minimum Noise Susceptibility (CNY17FXM, MOC8106M)
- Safety and Regulatory Approvals:
 - ◆ UL1577, 4,170 VAC_{RMS} for 1 Minute
 - ◆ DIN-EN/IEC60747-5-5, 850 V Peak Working Insulation Voltage

Applications

- Power Supply Regulators
- Digital Logic Inputs
- Microprocessor Inputs
- Appliance Sensor Systems
- Industrial Controls



PDIP6 CASE 646BY

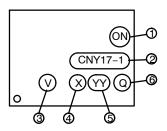


PDIP6 CASE 646BX



PDIP6 CASE 646BZ

MARKING DIAGRAM



1. ON = **onsemi** Logo 2. CNY17 = Device Number

3. V = DIN EN/IEC60747-5-5 Option

(only appears on component ordered

with this option)

4 X = One-Digit Year Code
5. YY = Digit Work Week
6. Q = Assembly Package Code

ORDERING INFORMATION

See detailed ordering and shipping information on page 8 of this data sheet.

SCHEMATICS

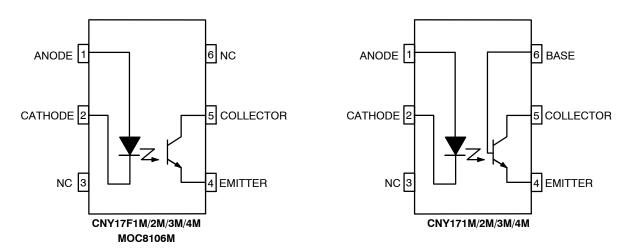


Figure 1. Schematics

SAFETY AND INSULATION RATINGS

As per DIN EN/IEC 60747–5–5, this optocoupler is suitable for "safe electrical insulation" only within the safety limit data. Compliance with the safety ratings shall be ensured by means of protective circuits.

Para	Parameter	
Installation Classifications per DIN VDE 0110/1.89 Table 1, For Rated Mains	< 150 V _{RMS}	I–IV
Voltage	< 300 V _{RMS}	I–IV
Climatic Classification	55/100/21	
Pollution Degree (DIN VDE 0110/1.89)	2	
Comparative Tracking Index		175

Symbol	Parameter	Value	Unit
V _{PR}	Input-to-Output Test Voltage, Method A, $V_{IORM} \times 1.6 = V_{PR}$, Type and Sample Test with $t_m = 10 \text{ s}$, Partial Discharge < 5 pC	1360	Vpeak
	Input-to-Output Test Voltage, Method B, $V_{IORM} \times 1.875 = V_{PR}$, 100% Production Test with $t_m = 1$ s, Partial Discharge < 5 pC	1594	Vpeak
V _{IORM}	Maximum Working Insulation Voltage	850	Vpeak
V _{IOTM}	Highest Allowable Over-Voltage	6000	Vpeak
	External Creepage	≥ 7	mm
	External Clearance	≥ 7	mm
	External Clearance (for Option TV, 0.4" Lead Spacing)	≥ 10	mm
DTI	Distance Through Insulation (Insulation Thickness)	≥ 0.5	mm
T _S	Case Temperature (Note 1)	175	°C
I _{S, INPUT}	Input Current (Note 1)	350	mA
P _{S, OUTPUT}	Output Power (Note 1)	800	mW
R _{IO}	Insulation Resistance at T _S , V _{IO} = 500 V (Note 1)	> 10 ⁹	Ω

^{1.} Safety limit values – maximum values allowed in the event of a failure.

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
TOTAL DEVICE	•		
T _{STG}	Storage Temperature	-40 to +125	°C
T _A	T _A Ambient Operating Temperature		°C
T_J	T _J Junction Temperature		°C
T _{SOL} Lead Solder Temperature		260 for 10 seconds	°C
P _D	Total Device Power Dissipation @ 25°C (LED plus detector)	270	mW
	Derate Linearly From 25°C	2.94	mW/°C
EMITTER	•		
l _F	Continuous Forward Current	60	mA
V _R	Reverse Voltage	6	V
I _F (pk)	Forward Current – Peak (1 μs pulse, 300 pps)	1.5	Α
P_{D}	LED Power Dissipation 25°C Ambient	120	mW
	Derate Linearly From 25°C	1.41	mW/°C
DETECTOR			
I _C	Continuous Collector Current	50	mA
V _{CEO}	Collector-Emitter Voltage	70	V
V _{ECO}	Emitter Collector Voltage	7	V
P _D	Detector Power Dissipation @ 25°C	150	mW
	Derate Linearly from 25°C	1.76	mW/°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

ELECTRICAL CHARACTERISTICS

 $(T_A = 25^{\circ}C \text{ unless otherwise specified})$

INDIVIDUAL COMPONENT CHARACTERISTICS

Symbol	Parameter	Test Conditions	Device	Min.	Тур.	Max.	Unit
EMITTER							
V _F	Input Forward Voltage	I _F = 10 mA	All Devices	1.0	1.15	1.50	V
		I _F = 60 mA	CNY17XM, CNY17FXM	1.0	1.35	1.65	V
CJ	Capacitance	V _F = 0 V, f = 1.0 MHz	All Devices	-	18	-	pF
I _R	Reverse Leakage Current	V _R = 6 V	All Devices	-	0.001	10	μΑ
DETECTO	R	•					
BV _{CEO}	Breakdown Voltage Collector-to-Emitter	I _C = 1 mA, I _F = 0	All Devices	70	100	_	V
BV _{CBO}	Collector-to-Base	$I_C = 10 \mu A, I_F = 0$	CNY17XM	70	120	-	V
BV _{ECO}	Emitter-to-Collector	I _E = 100 μA, I _F = 0	All Devices	7	10	-	V
I _{CEO}	Leakage Current Collector-to-Emitter	V _{CE} = 10 V, I _F = 0	All Devices	-	1	50	nA
I _{CBO}	Collector-to-Base	V _{CB} = 10 V, I _F = 0	CNY17XM	-	-	20	nA
C _{CE}	Capacitance Collector-to-Emitter	V _{CE} = 0, f = 1 MHz	All Devices	-	8	-	pF
C _{CB}	Collector-to-Base	V _{CB} = 0, f = 1 MHz	CNY17XM	1	20	_	pF
C _{EB}	Emitter-to-Base	V _{EB} = 0, f = 1 MHz	CNY17XM	-	10	-	pF

TRANSFER CHARACTERISTICS

Symbol	Parameter	Test Conditions	Device	Min.	Тур.	Max.	Unit
COUPLED							
CTR	Current Transfer Ratio	I _F = 10 mA, V _{CE} = 10 V	MOC8106M	50	-	150	%
		I _F = 10 mA, V _{CE} = 5 V	CNY171M, CNY17F1M	40	-	80	%
		I _F = 10 mA, V _{CE} = 5 V	CNY172M, CNY17F2M	63	-	125	%
		I _F = 10 mA, V _{CE} = 5 V	CNY173M, CNY17F3M	100	-	200	%
		I _F = 10 mA, V _{CE} = 5 V	CNY174M, CNY17F4M	160	-	320	%
V _{CE(SAT)}	Collector-Emitter	I _C = 0.5 mA, I _F = 5 mA	MOC8106M	-	-	0.4	V
	Saturation Voltage	I _C = 2.5 mA, I _F = 10 mA	CNY17XM/CNY17FXM	-	-		

AC CHARACTERISTICS

Symbol	Parameter	Test Conditions	Device	Min.	Тур.	Max.	Unit
NON-SAT	URATED SWITCHING	G TIME					
ton	Turn-On Time	I_C = 2.0 mA, V_{CC} = 10 V, R_L = 100 Ω	All Devices	_	2.0	10.0	μs
toff	Turn-Off Time	I_C = 2.0 mA, V_{CC} = 10 V, R_L = 100 Ω	All Devices	_	3.0	10.0	μs
t _d	Delay Time	I_F = 10 mA, V_{CC} = 5 V, R_L = 75 Ω	CNY17XM/CNY17FXM	_	-	5.6	μs
t _r	Rise Time	I_F = 10 mA, V_{CC} = 5 V, R_L = 75 Ω	CNY17XM/CNY17FXM	_	-	4.0	μs
t _s	Storage Time	I_F = 10 mA, V_{CC} = 5 V, R_L = 75 Ω	CNY17XM/CNY17FXM	_	-	4.1	μs
t _f	Fall Time	I_F = 10 mA, V_{CC} = 5 V, R_L = 75 Ω	CNY17XM/CNY17FXM	-	-	3.5	μs
SATURATI	ED SWITCHING TIME	<u> </u>					
t _d		I_F = 20 mA, V_{CC} = 5 V, R_L = 1 k Ω	CNY171M/F1M	_	-	5.5	μs
	Delay Time	I_F = 10 mA, V_{CC} = 5 V, R_L = 1 k Ω	CNY172M/3M/4M CNY17F2M/F3M/F4M	-	-	8.0	μs
t _r		I_F = 20 mA, V_{CC} = 5 V, R_L = 1 k Ω	CNY171M/F1M	_	-	4.0	μs
	Rise Time	I_F = 10 mA, V_{CC} = 5 V, R_L = 1 k Ω	CNY172M/3M/4M CNY17F2M/F3M/F4M	-	-	6.0	μs
t _s		I_F = 20 mA, V_{CC} = 5 V, R_L = 1 k Ω	CNY171M/F1M	-	-	34.0	μs
	Storage Time	I_F = 10 mA, V_{CC} = 5 V, R_L = 1 k Ω	CNY172M/3M/4M CNY17F2M/F3M/F4M	-	-	39.0	μs
t _f		I_F = 20 mA, V_{CC} = 5 V, R_L = 1 k Ω	CNY171M/F1M	_	-	20.0	μs
	Fall Time	I_F = 10 mA, V_{CC} = 5 V, R_L = 1 k Ω	CNY172M/3M/4M CNY17F2M/F3M/F4M	_	-	24.0	μs

ISOLATION CHARACTERISTICS

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
VISO	Input-Output Isolation Voltage	t = 1 Minute	4170	-	-	VAC _{RMS}
CISO	Isolation Capacitance	V _{I-O} = 0 V, f = 1 MHz	-	0.2	-	pF
RISO	Isolation Resistance	$V_{I-O} = \pm 500 \text{ VDC}, T_A = 25^{\circ}\text{C}$	10 ¹¹	ı	-	Ω

TYPICAL PERFORMANCE CHARACTERISTICS

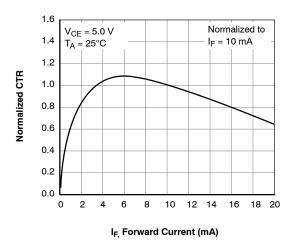


Figure 2. Normalized CTR vs. Forward Current

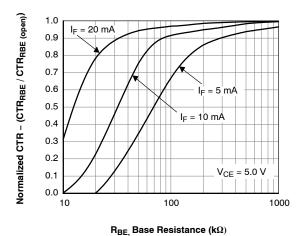


Figure 4. CTR vs. RBE (Unsaturated)

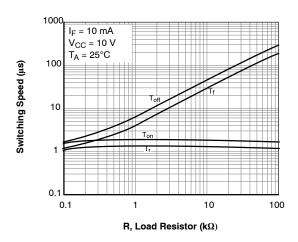


Figure 6. Switching Speed vs. Load Resistor

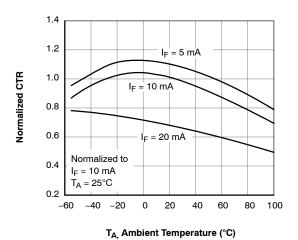


Figure 3. Normalized CTR vs. Ambient

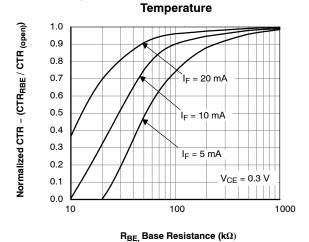


Figure 5. CTR vs. RBE (Saturated)

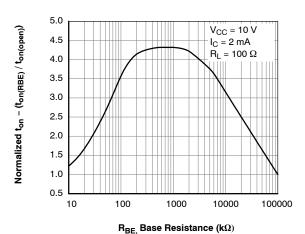
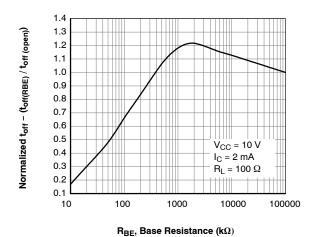


Figure 7. Normalized ton vs. RBE

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)



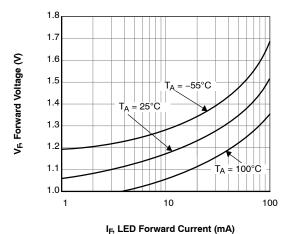


Figure 8. Normalized t_{off} vs. R_{BE}

Figure 9. LED Forward Voltage vs. Forward Current

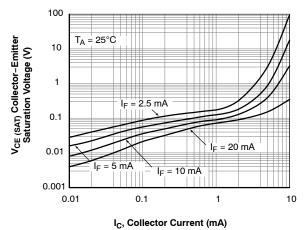


Figure 10. Collector-Emitter Saturation Voltage vs. Collector Current

SWITCHING TEST CIRCUIT AND WAVEFORMS

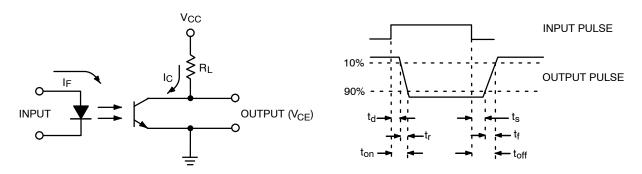


Figure 11. Switching Test Circuit and Waveforms

REFLOW PROFILE

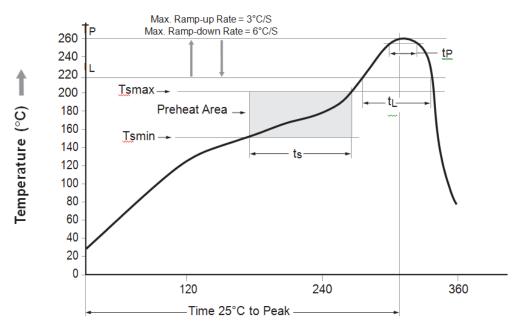


Figure 12. Reflow Profile

Profile Feature	Pb – Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (t _S) from (Tsmin to Tsmax)	60-120 seconds
Ramp – up Rate (tto t _P)	3°C/second max.
Liquidous Temperature (T _L)	217°C
Time (t _L) Maintained Above (T _L)	60-150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (t _P) within 5°C of 260°C	30 seconds
Ramp – down Rate (T _P to T _L)	6°C / second max.
Time 25°C to Peak Temperature	8 minutes max.

Table 1. ORDERING INFORMATION

Part Number	Package	Packing Method†
CNY171M	DIP 6-Pin	Tube (50 Units)
CNY171SM	SMT 6-Pin (Lead Bend)	Tube (50 Units)
CNY171SR2M	SMT 6-Pin (Lead Bend)	Tape and Reel (1000 Units)
CNY171TM	DIP 6-Pin, 0.4" Lead Spacing	Tube (50 Units)
CNY171VM	DIP 6-Pin, DIN EN/IEC60747-5-5 Option	Tube (50 Units)
CNY171SVM	SMT 6-Pin (Lead Bend), DIN EN/IEC60747-5-5 Option	Tube (50 Units)
CNY171SR2VM	SMT 6-Pin (Lead Bend), DIN EN/IEC60747-5-5 Option	Tape and Reel (1000 Units)
CNY171TVM	DIP 6-Pin, 0.4" Lead Spacing, DIN EN/IEC60747-5-5 Option	Tube (50 Units)

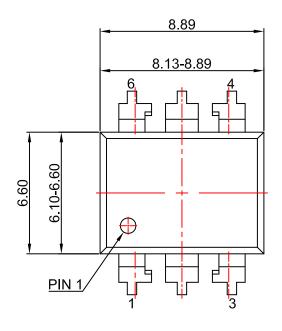
[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

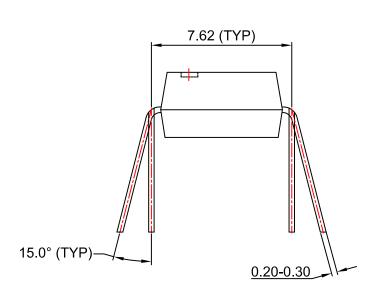
^{2.} The product orderable part number system listed in this table also applies to the CNY17FXM product family and the MOC8106M device.

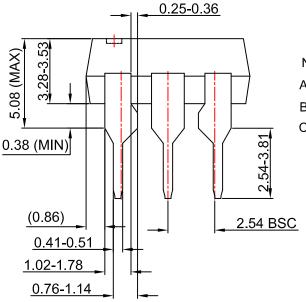


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DATE 31 JUL 2016







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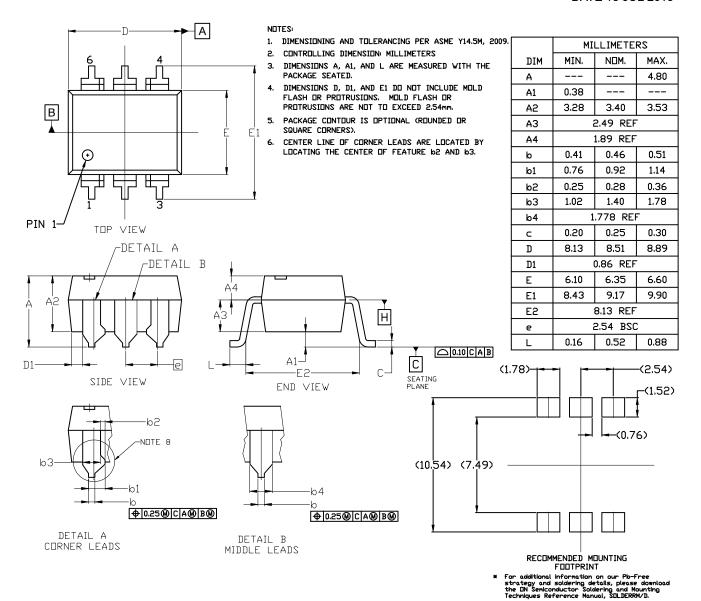
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PACKAGE DIMENSIONS

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DATE 15 JUL 2019



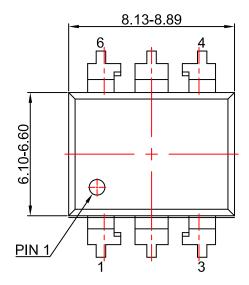
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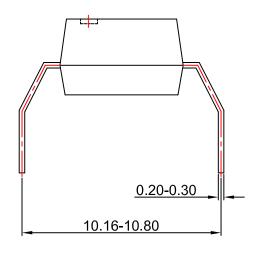
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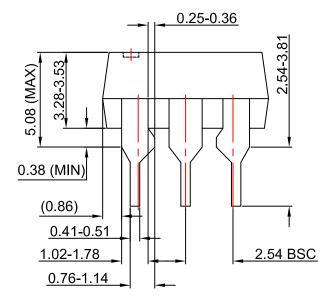


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MOC8106M CNY17F1TVM CNY17F4SR2VM CNY17F3TVM CNY174M CNY174SM CNY174SR2M
CNY174SR2VM CNY174SVM CNY174TVM CNY174VM CNY17F1M CNY17F1SM CNY17F1SR2M
CNY17F1SR2VM CNY17F1VM CNY17F2M CNY17F2SM CNY17F2SR2M CNY17F2SR2VM CNY17F2SVM
CNY17F2TVM CNY17F2VM CNY17F3M CNY17F3SM CNY17F3SR2M CNY17F3SR2VM CNY17F3VM
CNY17F4M CNY17F4SM CNY17F4SR2M CNY17F4SVM CNY17F4TVM CNY17F4VM MOC8106SR2VM
CNY17ZTVM CNY17ZSR2M CNY17ZSNM CNY17ZSNM CNY17ZSR2WM CNY17ZSR2VM